

650V 100A FieldStop Trench IGBT

Description

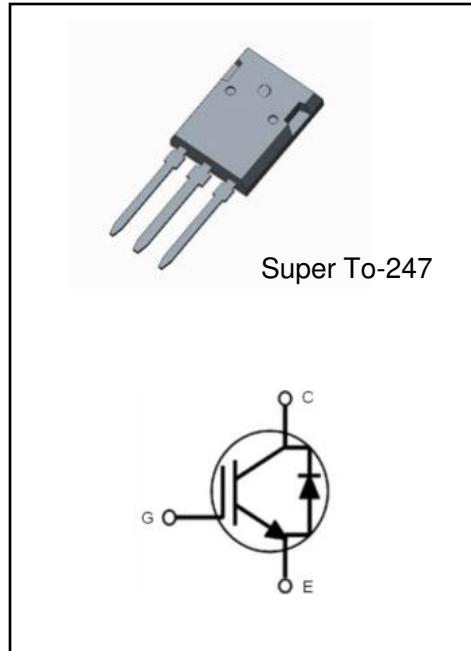
The device is designed by advanced FieldStop Trench technology process. This IGBT offer low $V_{CE(sat)}$, high speed switching performance and excellent quality for application such as PFC,UPS, Welder, PV Inverter, Solar Inverter and other switching applications.

Features

- FieldStop Trench Technology, Positive temperature coefficient
- $V_{CE(sat)}=1.58V@I_C=100A$
- High Speed Switching & Low Power Loss
- High Input Impedance
- SiC Schottky Barrier Diode

Applications

- PFC, UPS, Welder, PV Inverter, Solar Inverter



Absolute Maximum Ratings

| Symbol | Parameter | | Ratings | Unit |
|-----------|--------------------------------------|-------------------|----------|------|
| V_{CES} | Collector to Emitter Voltage | | 650 | V |
| V_{GES} | Gate to Emitter Voltage | | ± 20 | V |
| I_C | Collector Current | $T_C=25^\circ C$ | 180 | A |
| | | $T_C=125^\circ C$ | 100 | A |
| I_{CM} | Pulsed Collector Current | | 300 | A |
| I_F | Diode Continuous Forward Current | $T_C=125^\circ C$ | 30 | A |
| I_{FSM} | Non-repetitive Peak Surge Current | | 150 | A |
| P_D | Maximum Power Dissipation | $T_C=25^\circ C$ | 428 | W |
| | | $T_C=125^\circ C$ | 214 | W |
| T_J | Operating Junction Temperature Range | | -50~+175 | °C |
| T_{STG} | Storage Temperature Range | | -50~+150 | °C |

Thermal Characteristics

| Symbol | Parameter | Ratings | Unit |
|-----------------------|--|---------|------|
| $R_{th(J-C)}$ (IGBT) | Thermal Resistance, Junction to case for IGBT | 0.35 | °C/W |
| $R_{th(J-C)}$ (Diode) | Thermal Resistance, Junction to case for Diode | 0.78 | °C/W |
| $R_{th(J-A)}$ | Thermal Resistance, Junction to Ambient | 40 | °C/W |

Electrical Characteristics of IGBT @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|----------------------|---|--|------|------|-----------|---------------|
| BV_{CES} | Collector to Emitter Breakdown Voltage | $V_{GE}=0\text{V}$, $I_C=250\mu\text{A}$ | 650 | - | - | V |
| $V_{CE(\text{sat})}$ | Collector to Emitter Saturation Voltage | $I_C=100\text{A}$, $V_{GE}=15\text{V}$ | - | 1.58 | 1.8 | V |
| | | $I_C=100\text{A}$, $V_{GE}=15\text{V}$, $T_C=125\text{ }^\circ\text{C}$ | - | 1.90 | - | V |
| $V_{GE(\text{th})}$ | Gate Threshold Voltage | $V_{CE}=V_{GE}$, $I_C=250\mu\text{A}$ | 4.0 | 4.5 | 6.0 | V |
| I_{CES} | Zero Gate Voltage Collector Current | $V_{CE}=V_{CES}$, $V_{GE}=0\text{V}$ | - | - | 10 | μA |
| I_{GES} | Gate to Emitter Leakage Current | $V_{GE}=V_{GES}$, $V_{CE}=0\text{V}$ | - | - | ± 250 | nA |

Electrical Characteristics of Sic SBD @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------|-------------------------|---|------|------|------|---------------|
| V_F | Forward Voltage Drop | $I_F=30\text{A}$ | - | 1.47 | 1.8 | V |
| | | $I_F=30\text{A}$, $T_J=125\text{ }^\circ\text{C}$ | - | 1.6 | 2.0 | V |
| I_R | Reverse Leakage Current | $V_R=650\text{V}$, | - | | 10 | μA |
| Q_C | Total Capacitive Charge | $V_R=325\text{V}$, $I_F=30\text{A}$, $dI/dt=-200\text{A}/\mu\text{s}$ | - | 40 | - | nC |
| C | Total Capacitive Charge | $V_R=0\text{V}$, $f=1\text{MHz}$ | - | 870 | - | pF |
| | | $V_R=200\text{V}$, $f=1\text{MHz}$ | - | 80 | - | |
| | | $V_R=400\text{V}$, $f=1\text{MHz}$ | - | 64 | - | |

Switching Characteristics @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------------|-------------------------------|---|------|-------|------|-------------|
| $t_{d(on)}$ | Turn-on Delay Time | $I_C=100\text{A}$, $V_{CC}=325\text{V}$, $V_{GE}=15\text{V}$, $R_G=7\Omega$, Inductive Load, $T_C=25\text{ }^\circ\text{C}$ | - | 32.4 | - | ns |
| t_r | Rising Time | | - | 39.2 | - | ns |
| $t_{d(off)}$ | Turn-off Delay Time | | - | 135.6 | - | ns |
| t_f | Falling Time | | - | 39.8 | - | ns |
| E_{on} | Turn-on Switching Loss | | - | 1.50 | - | mJ |
| E_{off} | Turn-off Switching Loss | | - | 0.69 | - | mJ |
| E_{ts} | Total Switching Loss | | - | 2.17 | - | mJ |
| $t_{d(on)}$ | Turn-on Delay Time | $I_C=100\text{A}$, $V_{CC}=325\text{V}$, $V_{GE}=15\text{V}$, $R_G=7\Omega$, Inductive Load, $T_C=125\text{ }^\circ\text{C}$ | - | 31.8 | - | ns |
| t_r | Rising Time | | - | 63.4 | - | ns |
| $t_{d(off)}$ | Turn-off Delay Time | | - | 147.2 | - | ns |
| t_f | Falling Time | | - | 56.0 | - | ns |
| E_{on} | Turn-on Switching Loss | | - | 2.00 | - | mJ |
| E_{off} | Turn-off Switching Loss | | - | 1.12 | - | mJ |
| E_{ts} | Total Switching Loss | | - | 3.02 | - | mJ |
| C_{ies} | Input Capacitance | $V_{GE}=0\text{V}$, $V_{CE}=25\text{V}$, $f=1.0\text{MHz}$ | - | 3680 | - | pF |
| C_{res} | Reverse Transfer Capacitance | | - | 109 | - | pF |
| C_{oes} | Output Capacitance | | - | 15 | - | pF |
| tsc | Short Circuit With stand Time | $V_{CC}=325\text{V}$, $V_{GE}=15\text{V}$ | 10 | - | - | us |

Typical Performance Characteristics

Fig. 1. Typical Output Characteristics

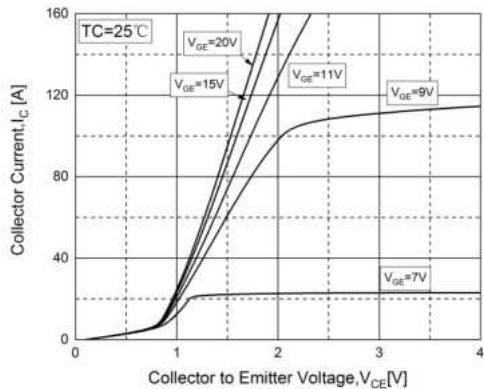


Fig. 2. Typical Saturation Voltage Characteristics

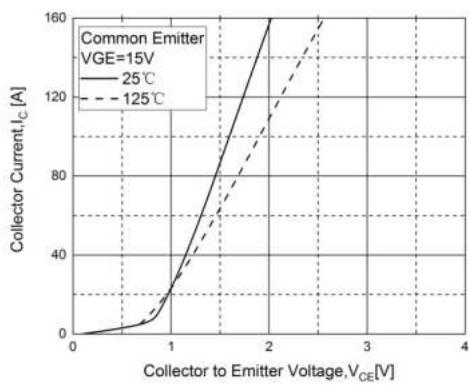


Fig. 3. Typical Saturation Voltage vs. T_c

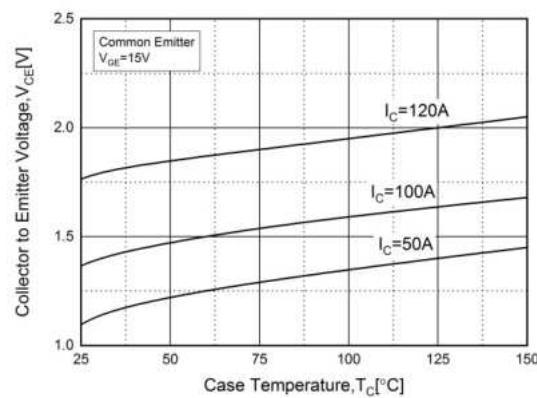


Fig. 4. Diode Forward Characteristics

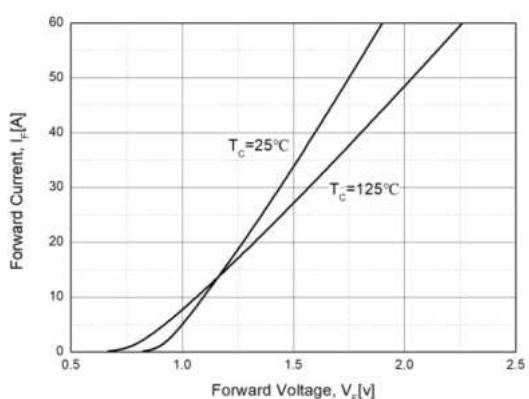


Fig. 5. Typical Capacitance Characteristics

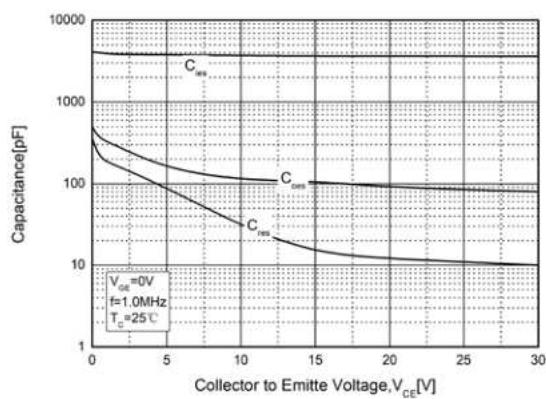
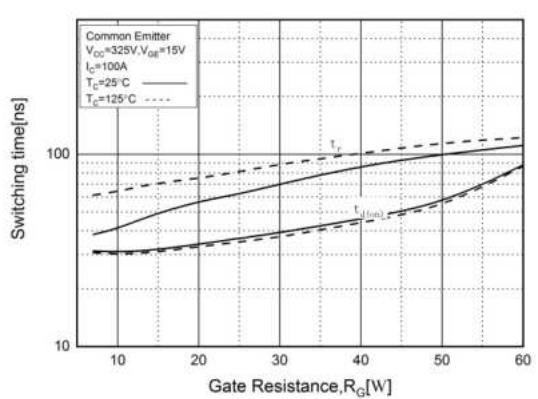


Fig. 6. Turn-on Characteristics vs. R_G



Typical Performance Characteristics

Fig. 7. Turn-off Characteristics vs. R_G

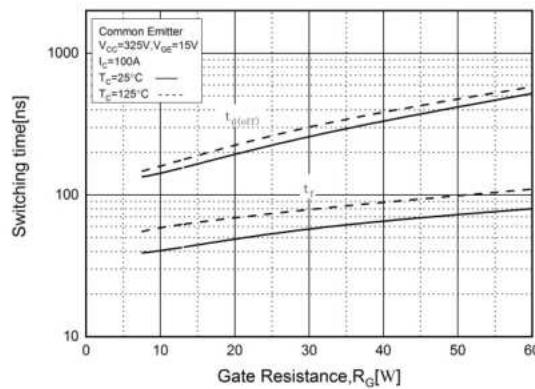


Fig. 8. Switching Loss vs. R_G

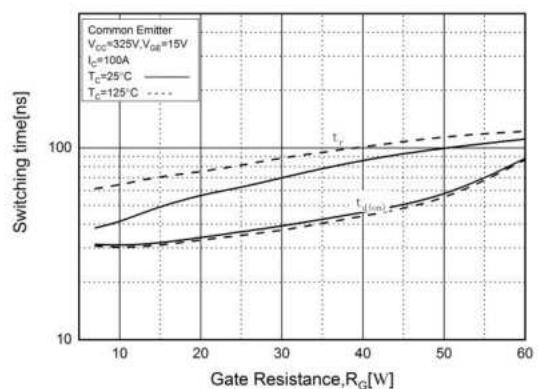


Fig. 9. Turn-on Characteristics vs. I_C

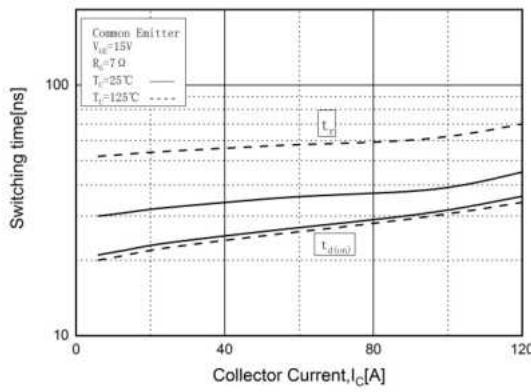


Fig. 10. Turn-off Characteristics vs. I_C

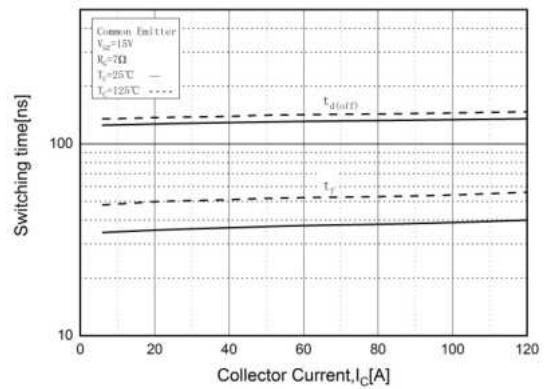
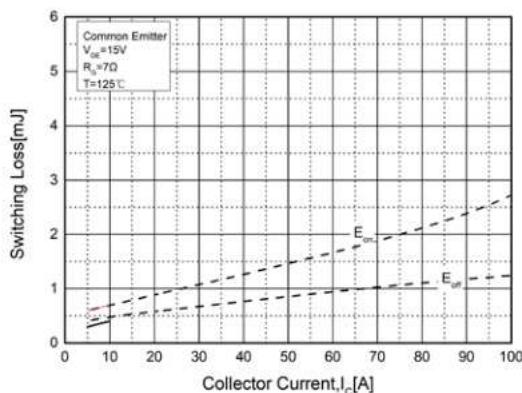


Fig. 11. Switching Loss vs. I_C



Package Dimensions**TO-247-Super**

(Dimensions in Millimeters)

